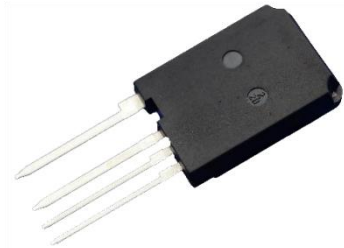
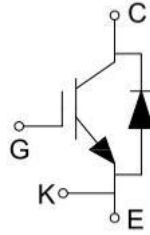


Trench Field-stop IGBT Discrete

Parameter	Value	Unit
V_{CE}	1200	V
I_C	120	A
$V_{CE(sat)}$	1.7	V



TO-247PLUS-4L

Features

- 1200V trench gate/field termination process
- Low switching losses
- V_{cesat} has a positive temperature coefficient

Applications

- Energy storage inverter
- Uninterruptible power supplies
- Solar inverters

IGBT

Maximum Ratings

Parameter	Symbol	Test condition	Value	Unit
Collector-Emitter voltage	V_{CES}	$T_{vj}=25^{\circ}C$	1200	V
Continuous DC collector current	$I_{C\ nom}$	$T_C=100^{\circ}C, T_{vj\ max}=175^{\circ}C$	120	A
Repetitive peak collector current	I_{CRM}	$t_p=1ms$	360	A
Gate-emitter voltage	V_{GE}		± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 0.5\mu s, D < 0.001$	± 25	V
Power dissipation	P_{tot}	$T_C=25^{\circ}C$ $T_C=100^{\circ}C$	1250 625	W
Temperature under switching conditions	$T_{vj\ op}$		-40...+175	$^{\circ}C$
Storage temperature	T_{stg}		-40...+150	$^{\circ}C$

Thermal Characteristics

Parameter	Symbol	Test condition	Value	Unit
IGBT thermal resistance, junction - case	$R_{th(j-C)}$		0.12	$^{\circ}C/W$
Diode thermal resistance, junction - case	$R_{th(j-C)}$		0.20	$^{\circ}C/W$

Characteristic Values

Parameter	Symbol	Test condition	Value			Unit	
			Min.	Typ.	Max.		
Collector-Emitter saturation voltage	V_{CEsat}	$V_{GE}=15V, I_C=120A$ $V_{GE}=15V, I_C=120A$	$T_{vj}=25^{\circ}C$ $T_{vj}=175^{\circ}C$	1.70 2.30	2.10	V	
Gate-Emitter threshold voltage	$V_{GE(th)}$	$I_C=2.34mA, V_{GE}=V_{CE}$	$T_{vj}=25^{\circ}C$	5.2	5.8	6.4	V
Transconductance	G_{fs}	$V_{CE}=20V, I_C=120A$		96		S	

Input capacitance	C_{ies}			16.81	nF
Output capacitance	C_{oes}	$f=100\text{kHz}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	0.41	nF
Reverse transfer capacitance	C_{res}			0.13	nF
Gate charge	Q_G			$I_C=120\text{A}, V_{GE}=15\text{V}, V_{CE}=960\text{V}$	$T_{vj}=25^\circ\text{C}$
Collector-emitter cut-off current	I_{CES}	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	40	μA
Gate-emitter leakage current	I_{GES}	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	$T_{vj}=25^\circ\text{C}$	100	nA
Turn-on delay time	$t_{d(on)}$	$I_C=120\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=20\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$	235	ns
			$T_{vj}=175^\circ\text{C}$	175	
Rise time	t_r	$I_C=120\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=20\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$	137	ns
			$T_{vj}=175^\circ\text{C}$	139	
Turn-off delay time	$t_{d(off)}$	$I_C=120\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=20\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$	435	ns
			$T_{vj}=175^\circ\text{C}$	489	
Fall time	t_f	$I_C=120\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=20\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$	69	ns
			$T_{vj}=175^\circ\text{C}$	126	
Turn-on energy loss per pulse	E_{on}	$I_C=120\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=20\Omega$ $di/dt=700\text{A}/\mu\text{s}(T_{vj}=175^\circ\text{C})$ (inductive load)	$T_{vj}=25^\circ\text{C}$	14.60	mJ
			$T_{vj}=175^\circ\text{C}$	19.74	
Turn-off energy loss per pulse	E_{off}	$I_C=120\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=20\Omega$ $dv/dt=7500\text{V}/\mu\text{s}(T_{vj}=175^\circ\text{C})$ (inductive load)	$T_{vj}=25^\circ\text{C}$	4.41	mJ
			$T_{vj}=175^\circ\text{C}$	6.74	

Diode

Maximum Ratings

Parameter	Symbol	Test condition	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj}=25^\circ\text{C}$	1200	V
Continuous DC forward current	I_F	$T_C=100^\circ\text{C}, T_{vj\text{max}}=175^\circ\text{C}$	120	A
Repetitive peak forward current	I_{FRM}	$t_p=1\text{ms}$	360	A

Characteristic Values

Parameter	Symbol	Test condition	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F=120\text{A}, V_{GE}=0\text{V}$ $I_F=120\text{A}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$ $T_{vj}=175^\circ\text{C}$	1.75 1.96	2.2	V
Peak reverse recovery current	I_{RM}	$I_F=120\text{A},$ $-di_f/dt=700\text{A}/\mu\text{s}(T_{vj}=175^\circ\text{C})$ $V_R=600\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^\circ\text{C}$ $T_{vj}=175^\circ\text{C}$	42 66		A
Reverse Recovered charge	Q_{rr}	$I_F=120\text{A},$ $-di_f/dt=700\text{A}/\mu\text{s}(T_{vj}=175^\circ\text{C})$ $V_R=600\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^\circ\text{C}$ $T_{vj}=175^\circ\text{C}$	8.19 20.97		μC
Reverse Recovery Time	t_{rr}	$I_F=120\text{A},$ $-di_f/dt=700\text{A}/\mu\text{s}(T_{vj}=175^\circ\text{C})$ $V_R=600\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^\circ\text{C}$ $T_{vj}=175^\circ\text{C}$	428 668		ns
Reverse recovered energy	E_{rec}	$I_F=120\text{A},$ $-di_f/dt=700\text{A}/\mu\text{s}(T_{vj}=175^\circ\text{C})$ $V_R=600\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^\circ\text{C}$ $T_{vj}=175^\circ\text{C}$	2.84 8.11		mJ

Typical Characteristics

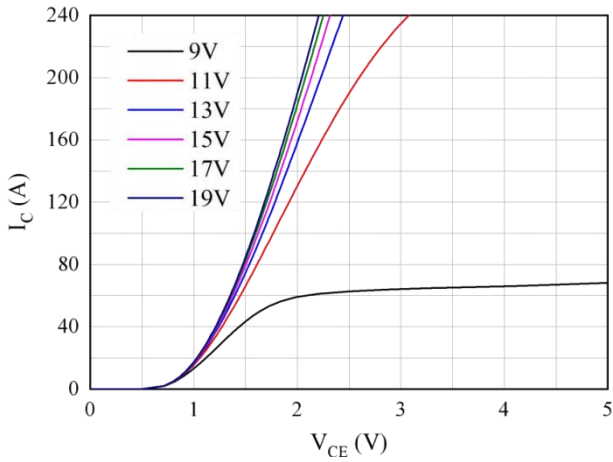


Fig 1. Typical output characteristics ($T_{vj}=25^{\circ}\text{C}$)

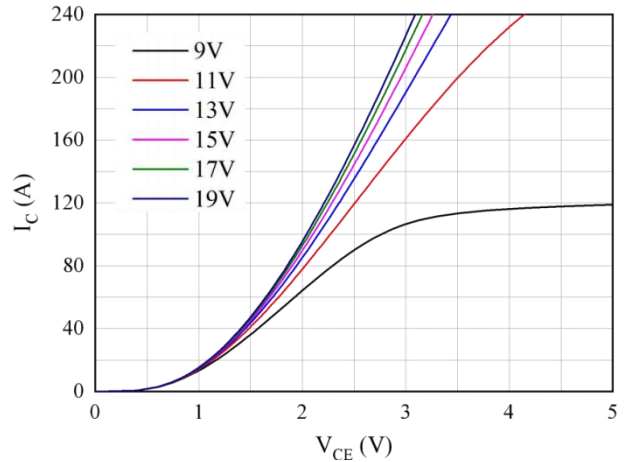


Fig 2. Typical output characteristics ($T_{vj}=175^{\circ}\text{C}$)

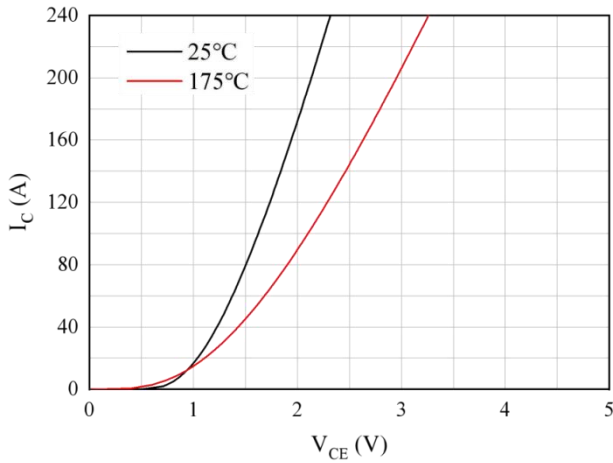


Fig 3. Typical output characteristics ($V_{ge}=15\text{V}$)

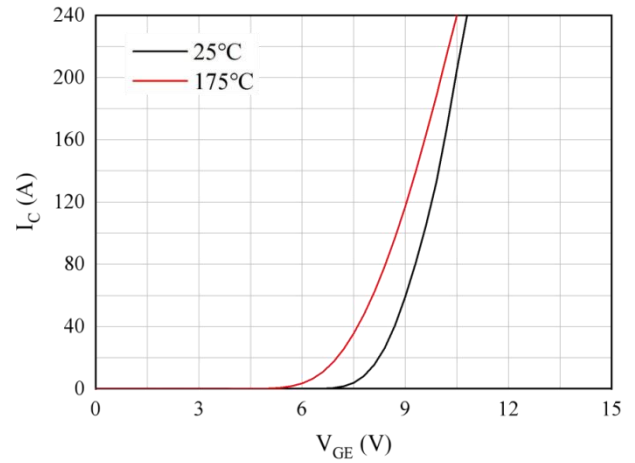


Fig 4. Typical transfer characteristic ($V_{ce}=20\text{V}$)

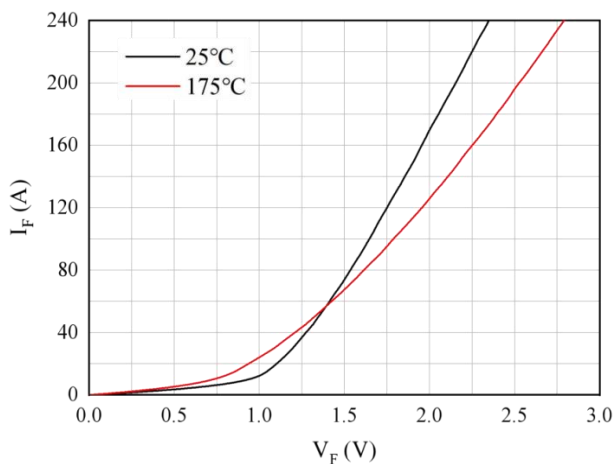


Fig 5. Forward characteristic of Diode

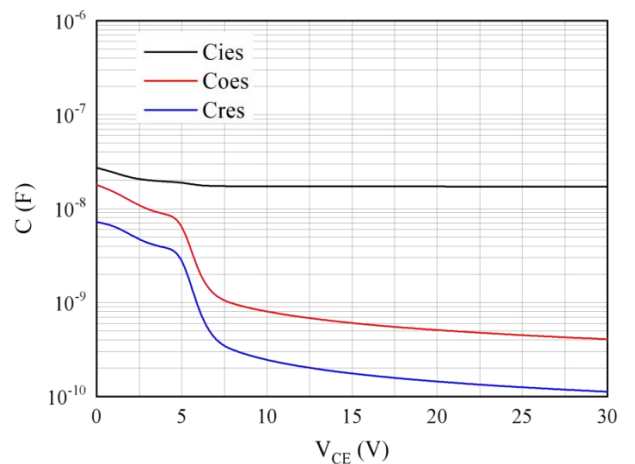


Fig 6. Capacitance characteristic

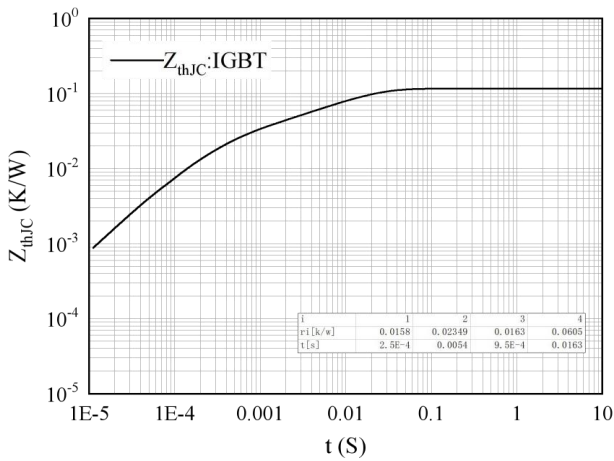


Fig 7. Transient thermal impedance IGBT,
 $Z_{thJC}=f(t)$

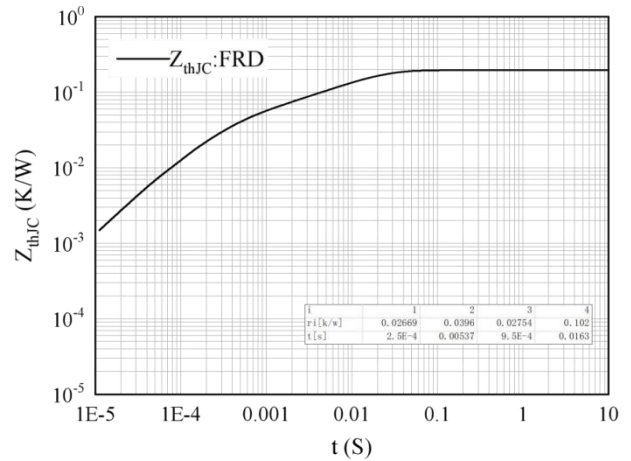


Fig 8. Transient thermal impedance FRD,
 $Z_{thJC}=f(t)$

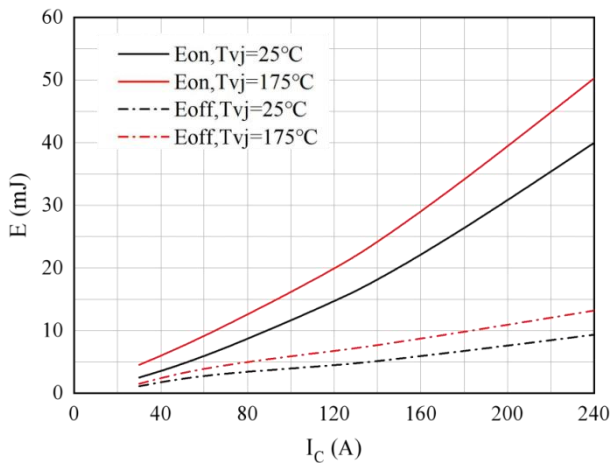


Fig 9. Switching losses of IGBT
 $V_{GE}=\pm 15V, R_{gon}=20\Omega, R_{goff}=20\Omega, V_{CE}=600V$

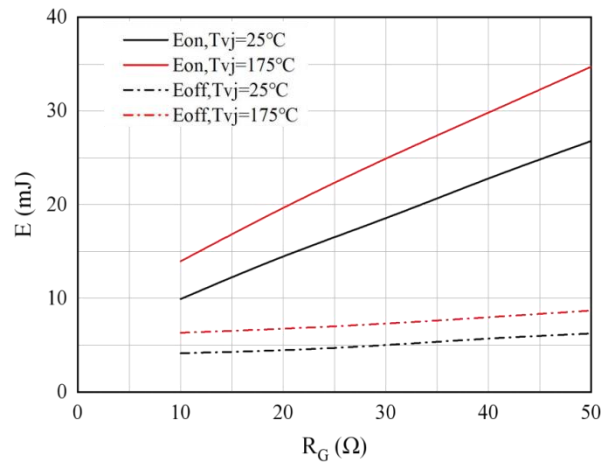


Fig 10. Switching losses of IGBT
 $V_{GE}=\pm 15V, I_C=120A, V_{CE}=600V$

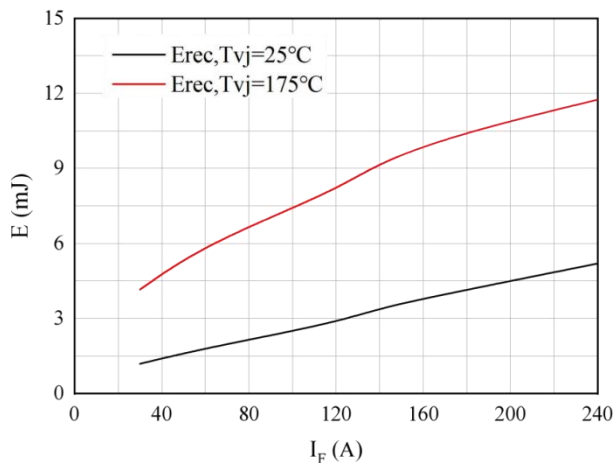


Fig 11. Switching losses of Diode
 $R_{gon}=20\Omega, V_{CE}=600V$

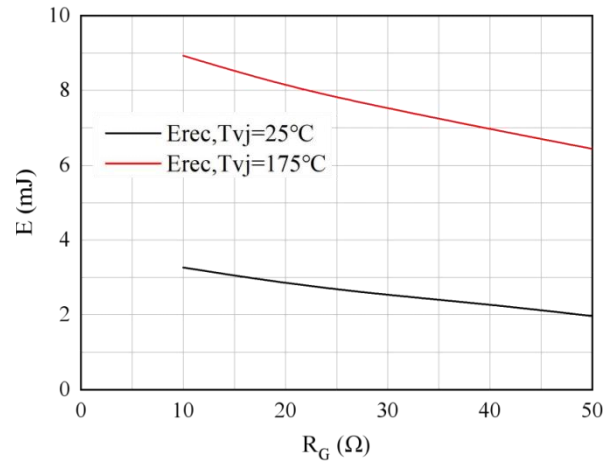
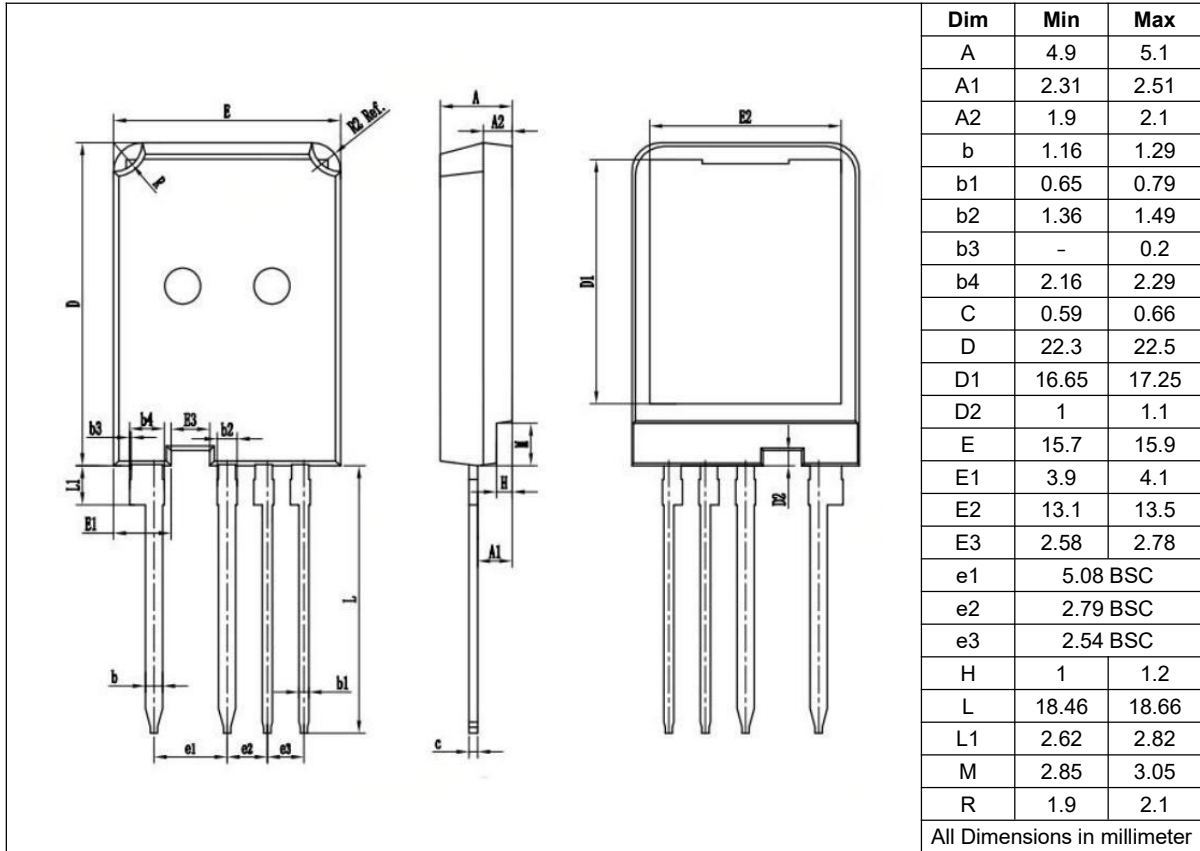


Fig 12. Switching losses of Diode
 $I_F=120A, V_{CE}=600V$

Package Outline (Unit: mm)

TO-247PLUS-4L



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